

Preliminary datasheet

EasyPIM™ module with TRENCHSTOP™ IGBT7 and Emitter Controlled 7 diode and PressFIT / NTC

Features

- Electrical features
 - TRENCHSTOP™ IGBT7
 - Overload operation up to 175°C
 - Low V_{CEsat}
- Mechanical features
 - High power density
 - PressFIT contact technology
 - 2.5 kV AC 1 min insulation
 - Al_2O_3 substrate with low thermal resistance
 - Compact design



Potential applications

- Auxiliary inverters
- Air conditioning
- Motor drives

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

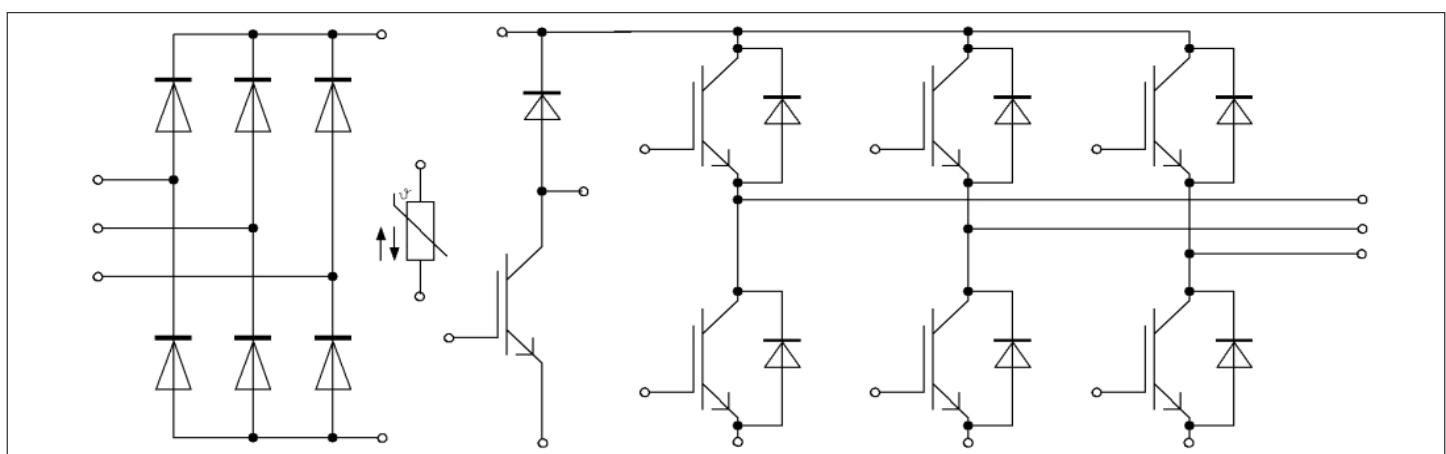


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1 Package

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Internal Isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	11.5	mm
Creepage distance	d_{Creep}	terminal to terminal	6.3	mm
Clearance	d_{Clear}	terminal to heatsink	10.0	mm
Clearance	d_{Clear}	terminal to terminal	5.0	mm
Comparative tracking index	CTI		> 200	
RTI Elec.	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			30		nH
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_H=25^\circ\text{C}$, per switch		6		mΩ
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_H=25^\circ\text{C}$, per switch		8		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting force per clamp	F		20		50	N
Weight	G			24		g

Note: The current under continuous operation is limited to 25A rms per connector pin.

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25^\circ\text{C}$	1200	V
Continous DC collector current	I_{CDC}	$T_{vj \max} = 175^\circ\text{C}$	10	A
Repetitive peak collector current	I_{CRM}	$t_P = 1 \text{ ms}$	20	A
Gate-emitter peak voltage	V_{GES}		±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 10 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.60	TBD
			$T_{vj} = 125^\circ\text{C}$		1.74	
			$T_{vj} = 175^\circ\text{C}$		1.82	
Gate threshold voltage	$V_{GE\text{th}}$	$I_C = 0.22 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$		5.15	5.80	6.45
Gate charge	Q_G	$V_{GE} = \pm 15 \text{ V}, V_{CE} = 600 \text{ V}$			0.157	
Internal gate resistor	$R_{G\text{int}}$	$T_{vj} = 25^\circ\text{C}$			0	
Input capacitance	C_{ies}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$			1.89	
Reverse transfer capacitance	C_{res}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$			0.0066	
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$			0.0045
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^\circ\text{C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.023	
			$T_{vj} = 125^\circ\text{C}$		0.025	
			$T_{vj} = 175^\circ\text{C}$		0.026	
Rise time (inductive load)	t_r	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.014	
			$T_{vj} = 125^\circ\text{C}$		0.017	
			$T_{vj} = 175^\circ\text{C}$		0.019	
Turn-off delay time (inductive load)	t_{doff}	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.124	
			$T_{vj} = 125^\circ\text{C}$		0.157	
			$T_{vj} = 175^\circ\text{C}$		0.176	
Fall time (inductive load)	t_f	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.227	
			$T_{vj} = 125^\circ\text{C}$		0.347	
			$T_{vj} = 175^\circ\text{C}$		0.422	
Turn-on energy loss per pulse	E_{on}	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, L_\sigma = 35 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 8.2 \Omega, di/dt = 550 \text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		0.73	
			$T_{vj} = 125^\circ\text{C}$		0.94	
			$T_{vj} = 175^\circ\text{C}$		1.13	
Turn-off energy loss per pulse	E_{off}	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, L_\sigma = 35 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 8.2 \Omega, dv/dt = 2700 \text{ V}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		0.623	
			$T_{vj} = 125^\circ\text{C}$		0.97	
			$T_{vj} = 175^\circ\text{C}$		1.17	
SC data	I_{SC}	$V_{GE} \leq 15 \text{ V}, V_{CC} = 800 \text{ V}, V_{CE\text{max}} = V_{CES} - L_{sCE} * di/dt$	$t_P \leq 8 \mu\text{s}, T_{vj} = 150^\circ\text{C}$		32	
			$t_P \leq 7 \mu\text{s}, T_{vj} = 175^\circ\text{C}$		30	

3 Diode, Inverter

Table 4 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction to heatsink	R_{thJH}	per IGBT		2.05		K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		175	°C

Note: $T_{vj\ op} > 150^\circ\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25^\circ\text{C}$	1200		V
Continuous DC forward current	I_F			10		A
Repetitive peak forward current	I_{FRM}	$t_P = 1\text{ ms}$		20		A
I^2t - value	I^2t	$V_R = 0\text{ V}, t_P = 10\text{ ms}$	$T_{vj} = 125^\circ\text{C}$	27.5		A^2s
			$T_{vj} = 175^\circ\text{C}$	24		

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 10\text{ A}, V_{GE} = 0\text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.72	TBD
			$T_{vj} = 125^\circ\text{C}$		1.59	
			$T_{vj} = 175^\circ\text{C}$		1.52	
Peak reverse recovery current	I_{RM}	$I_F = 10\text{ A}, V_R = 600\text{ V}, V_{GE} = -15\text{ V}, -di_F/dt = 550\text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		10.5	
			$T_{vj} = 125^\circ\text{C}$		15.3	
			$T_{vj} = 175^\circ\text{C}$		17.5	
Recovered charge	Q_r	$I_F = 10\text{ A}, V_R = 600\text{ V}, V_{GE} = -15\text{ V}, -di_F/dt = 550\text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		0.97	
			$T_{vj} = 125^\circ\text{C}$		1.7	
			$T_{vj} = 175^\circ\text{C}$		2.2	
Reverse recovery energy	E_{rec}	$I_F = 10\text{ A}, V_R = 600\text{ V}, V_{GE} = -15\text{ V}, -di_F/dt = 550\text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		0.24	
			$T_{vj} = 125^\circ\text{C}$		0.51	
			$T_{vj} = 175^\circ\text{C}$		0.72	

Table 6 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction to heatsink	R_{thJH}	per diode		2.45		K/W
Temperature under switching conditions	$T_{\text{vj op}}$		-40		175	°C

Note: $T_{\text{vj op}} > 150^{\circ}\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

4 Diode, Rectifier

Table 7 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{\text{vj}} = 25^{\circ}\text{C}$	1600			V
Maximum RMS forward current per chip	I_{FRMSM}	$T_{\text{H}} = 100^{\circ}\text{C}$	25			A
Maximum RMS current at rectifier output	I_{RMSM}	$T_{\text{H}} = 100^{\circ}\text{C}$	25			A
Surge forward current	I_{FSM}	$t_{\text{P}} = 10 \text{ ms}$	$T_{\text{vj}} = 25^{\circ}\text{C}$	300		A
			$T_{\text{vj}} = 150^{\circ}\text{C}$	245		
I^2t - value	I^2t	$t_{\text{P}} = 10 \text{ ms}$	$T_{\text{vj}} = 25^{\circ}\text{C}$	450		A^2s
			$T_{\text{vj}} = 150^{\circ}\text{C}$	300		

Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 10 \text{ A}$	$T_{\text{vj}} = 150^{\circ}\text{C}$		0.80	V
Reverse current	I_r	$T_{\text{vj}} = 150^{\circ}\text{C}, V_R = 1600 \text{ V}$		1		mA
Thermal resistance, junction to heatsink	R_{thJH}	per diode		1.54		K/W
Temperature under switching conditions	$T_{\text{vj, op}}$		-40		150	°C

5 IGBT, Brake-Chopper

5 IGBT, Brake-Chopper

Table 9 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25^\circ\text{C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj \max} = 175^\circ\text{C}$	10	A
Repetitive peak collector current	I_{CRM}	$t_P = 1 \text{ ms}$	20	A
Gate-emitter peak voltage	V_{GES}		± 20	V

Table 10 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE \text{ sat}}$	$I_C = 10 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$	1.60	TBD	V
			$T_{vj} = 125^\circ\text{C}$	1.74		
			$T_{vj} = 175^\circ\text{C}$	1.82		
Gate threshold voltage	$V_{GE \text{ th}}$	$I_C = 0.22 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	5.15	5.80	6.45	V
Gate charge	Q_G	$V_{GE} = \pm 15 \text{ V}, V_{CE} = 600 \text{ V}$		0.157		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25^\circ\text{C}$		0		Ω
Input capacitance	C_{ies}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$		1.89		nF
Reverse transfer capacitance	C_{res}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$		0.0066		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		0.0045	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^\circ\text{C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$	0.023		μs
			$T_{vj} = 125^\circ\text{C}$	0.025		
			$T_{vj} = 175^\circ\text{C}$	0.026		
Rise time (inductive load)	t_r	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$	0.014		μs
			$T_{vj} = 125^\circ\text{C}$	0.017		
			$T_{vj} = 175^\circ\text{C}$	0.019		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$	0.124		μs
			$T_{vj} = 125^\circ\text{C}$	0.157		
			$T_{vj} = 175^\circ\text{C}$	0.176		
Fall time (inductive load)	t_f	$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Goff} = 8.2 \Omega$	$T_{vj} = 25^\circ\text{C}$	0.227		μs
			$T_{vj} = 125^\circ\text{C}$	0.347		
			$T_{vj} = 175^\circ\text{C}$	0.422		

Table 10 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-on energy loss per pulse	E_{on}	$I_C = 10 \text{ A}$, $V_{\text{CE}} = 600 \text{ V}$, $L_\sigma = 35 \text{ nH}$, $V_{\text{GE}} = \pm 15 \text{ V}$, $R_{G_{\text{on}}} = 8.2 \Omega$, $\text{di/dt} = 550 \text{ A}/\mu\text{s}$ ($T_{vj} = 175 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.73	
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.94	
			$T_{vj} = 175 \text{ }^\circ\text{C}$		1.13	
Turn-off energy loss per pulse	E_{off}	$I_C = 10 \text{ A}$, $V_{\text{CE}} = 600 \text{ V}$, $L_\sigma = 35 \text{ nH}$, $V_{\text{GE}} = \pm 15 \text{ V}$, $R_{G_{\text{off}}} = 8.2 \Omega$, $\text{dv/dt} = 2700 \text{ V}/\mu\text{s}$ ($T_{vj} = 175 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.623	
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.97	
			$T_{vj} = 175 \text{ }^\circ\text{C}$		1.17	
SC data	I_{SC}	$V_{\text{GE}} \leq 15 \text{ V}$, $V_{\text{CC}} = 800 \text{ V}$, $V_{\text{CEmax}} = V_{\text{CES}} - L_{\text{SC}} * \text{di/dt}$	$t_P \leq 8 \mu\text{s}$, $T_{vj} = 150 \text{ }^\circ\text{C}$		32	
			$t_P \leq 7 \mu\text{s}$, $T_{vj} = 175 \text{ }^\circ\text{C}$		30	
Thermal resistance, junction to heatsink	R_{thJH}	per IGBT			2.05	
Temperature under switching conditions	$T_{vj \text{ op}}$			-40		175
						°C

Note: $T_{vj \text{ op}} > 150 \text{ }^\circ\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

6 Diode, Brake-Chopper

Table 11 Maximum rated values

Parameter	Symbol	Note or test condition	Values		Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25 \text{ }^\circ\text{C}$	1200	V
Continuous DC forward current	I_F			10	A
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$		20	A
I^2t - value	I^2t	$V_R = 0 \text{ V}$, $t_P = 10 \text{ ms}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	27.5	A^2s
			$T_{vj} = 175 \text{ }^\circ\text{C}$	24	

7 NTC-Thermistor

Table 12 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 10 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$	1.72	TBD	V
			$T_{vj} = 125^\circ\text{C}$	1.59		
			$T_{vj} = 175^\circ\text{C}$	1.52		
Peak reverse recovery current	I_{RM}	$I_F = 10 \text{ A}, V_R = 600 \text{ V}, -di_F/dt = 550 \text{ A}/\mu\text{s}$ ($T_{vj} = 175^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$	10.5		A
			$T_{vj} = 125^\circ\text{C}$	15.3		
			$T_{vj} = 175^\circ\text{C}$	17.5		
Recovered charge	Q_r	$I_F = 10 \text{ A}, V_R = 600 \text{ V}, -di_F/dt = 550 \text{ A}/\mu\text{s}$ ($T_{vj} = 175^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$	0.97		μC
			$T_{vj} = 125^\circ\text{C}$	1.7		
			$T_{vj} = 175^\circ\text{C}$	2.2		
Reverse recovery energy	E_{rec}	$I_F = 10 \text{ A}, V_R = 600 \text{ V}, -di_F/dt = 550 \text{ A}/\mu\text{s}$ ($T_{vj} = 175^\circ\text{C}$)	$T_{vj} = 25^\circ\text{C}$	0.24		mJ
			$T_{vj} = 125^\circ\text{C}$	0.51		
			$T_{vj} = 175^\circ\text{C}$	0.72		
Thermal resistance, junction to heatsink	R_{thJH}	per diode		2.45		K/W
Temperature under switching conditions	$T_{vj op}$		-40		175	°C

Note: $T_{vj op} > 150^\circ\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

7 NTC-Thermistor

Table 13 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25^\circ\text{C}$		5		kΩ
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100^\circ\text{C}, R_{100} = 493 \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25^\circ\text{C}$		20		mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$		3433		K

Note: Specification according to the valid application note.

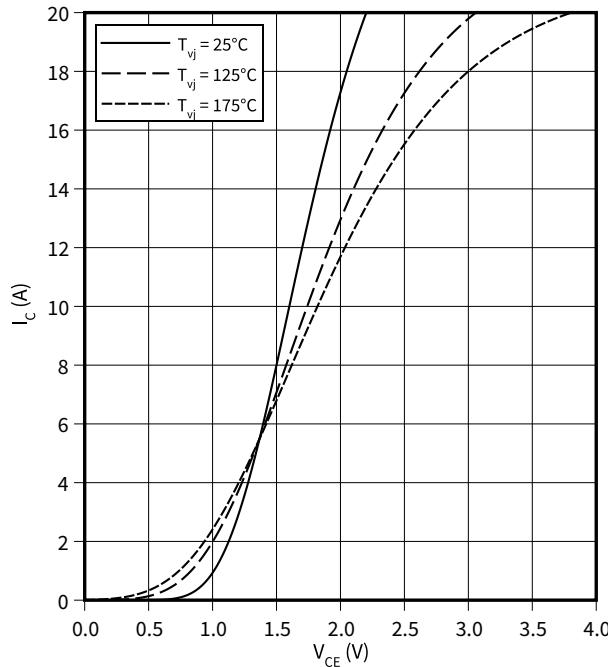
8 Characteristics diagrams

8 Characteristics diagrams

output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

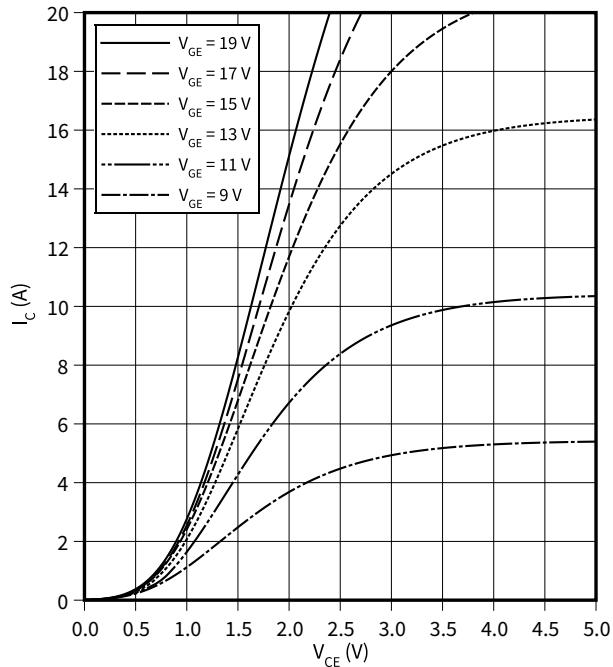
$$V_{GE} = 15 \text{ V}$$



output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

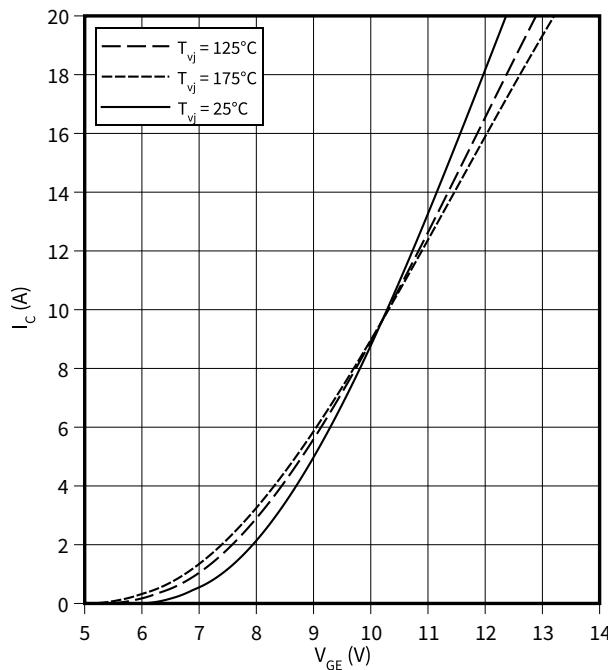
$$T_{vj} = 175 \text{ }^{\circ}\text{C}$$



transfer characteristic (typical), IGBT, Inverter

$$I_C = f(V_{GE})$$

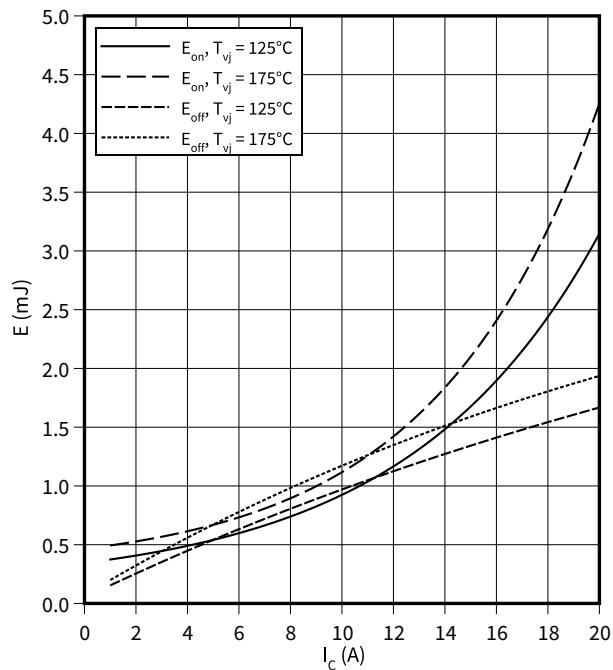
$$V_{CE} = 20 \text{ V}$$



switching losses (typical), IGBT, Inverter

$$E = f(I_C)$$

$$R_{Goff} = 8.2 \Omega, R_{Gon} = 8.2 \Omega, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$$

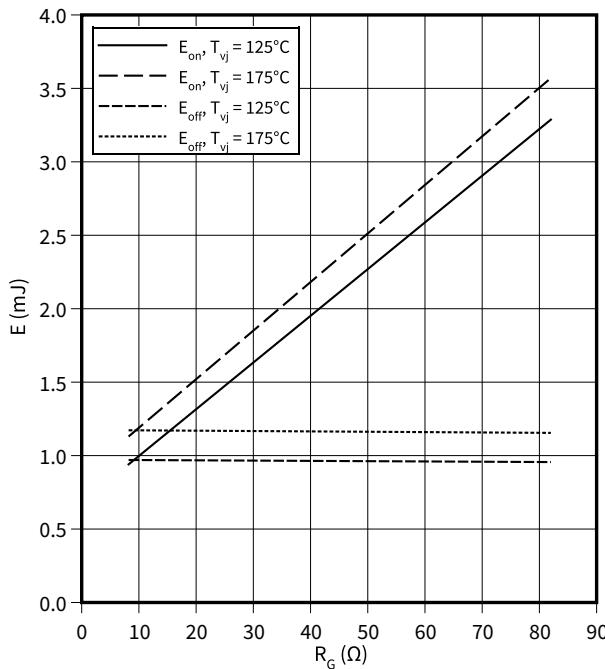


8 Characteristics diagrams

switching losses (typical), IGBT, Inverter

$$E = f(R_G)$$

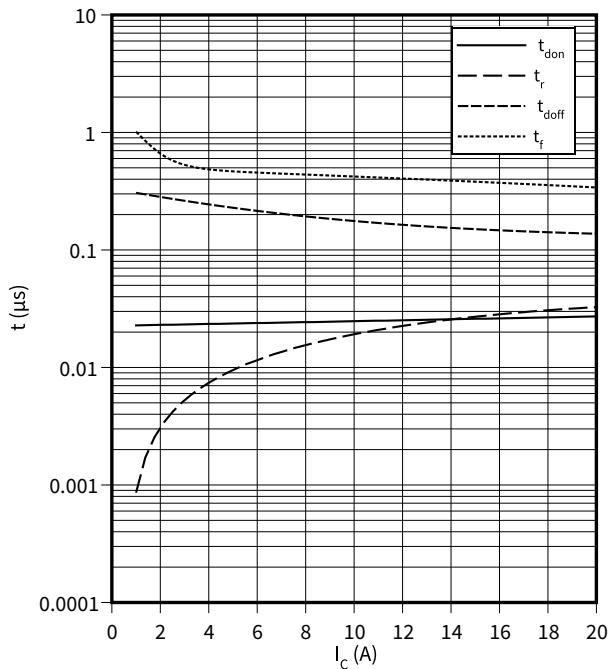
$$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$$



switching times (typical), IGBT, Inverter

$$t = f(I_C)$$

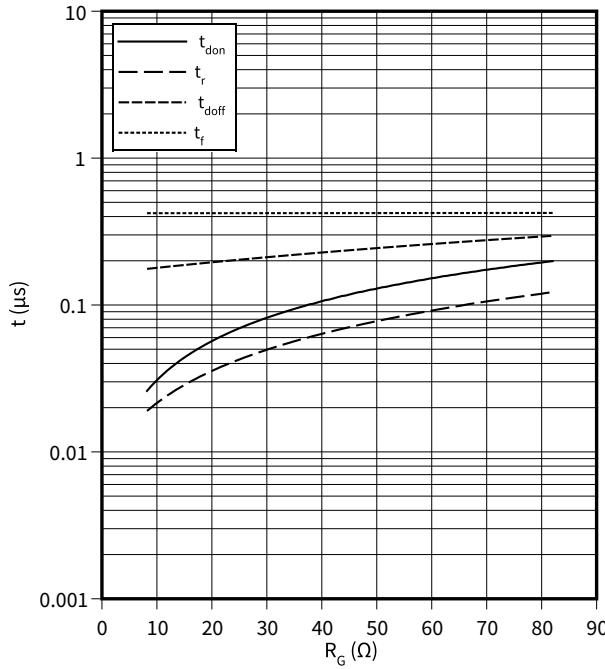
$$R_{Goff} = 8.2 \Omega, R_{Gon} = 8.2 \Omega, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 175^\circ\text{C}$$



switching times (typical), IGBT, Inverter

$$t = f(R_G)$$

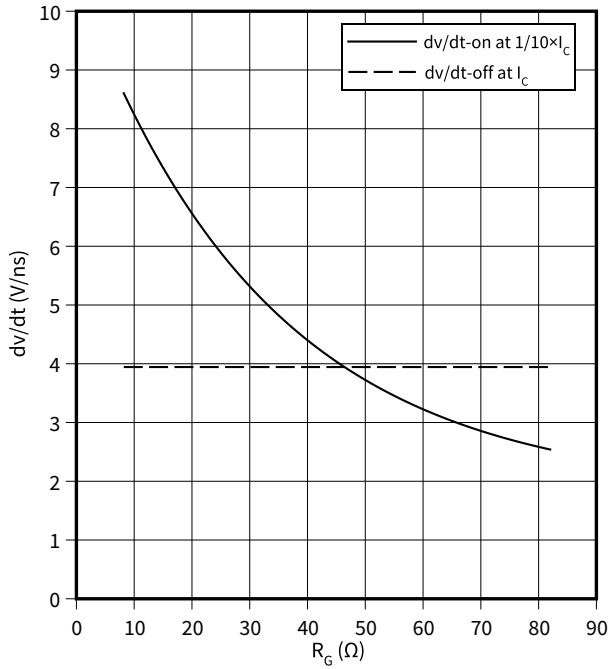
$$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 175^\circ\text{C}$$



dv/dt (typical), IGBT, Inverter

$$dv/dt = f(R_G)$$

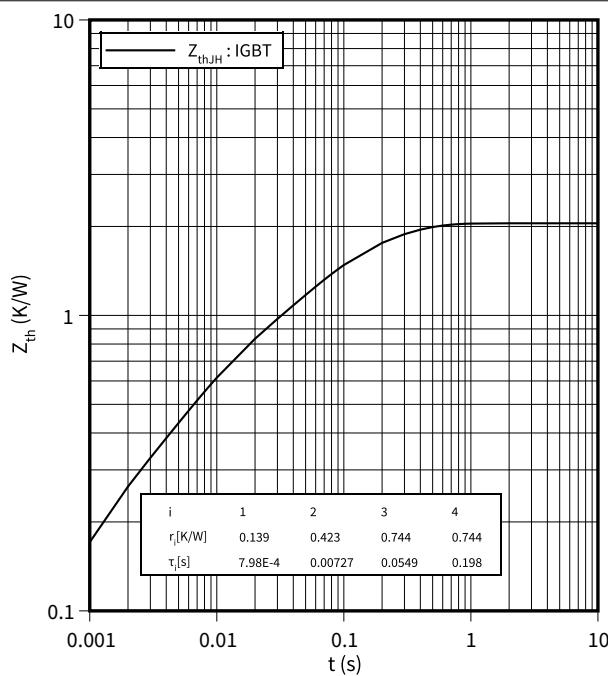
$$I_C = 10 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 25^\circ\text{C}$$



8 Characteristics diagrams

transient thermal impedance , IGBT, Inverter

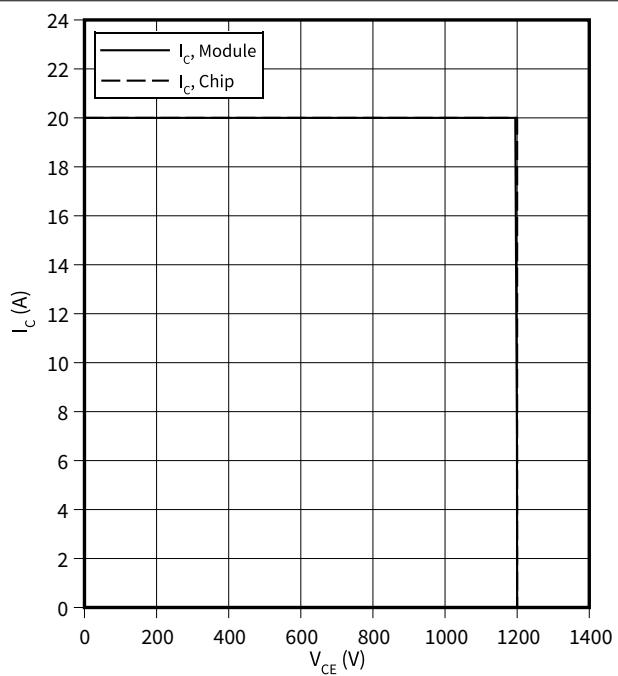
$$Z_{th} = f(t)$$



reverse bias safe operating area (RBSOA), IGBT, Inverter

$$I_C = f(V_{CE})$$

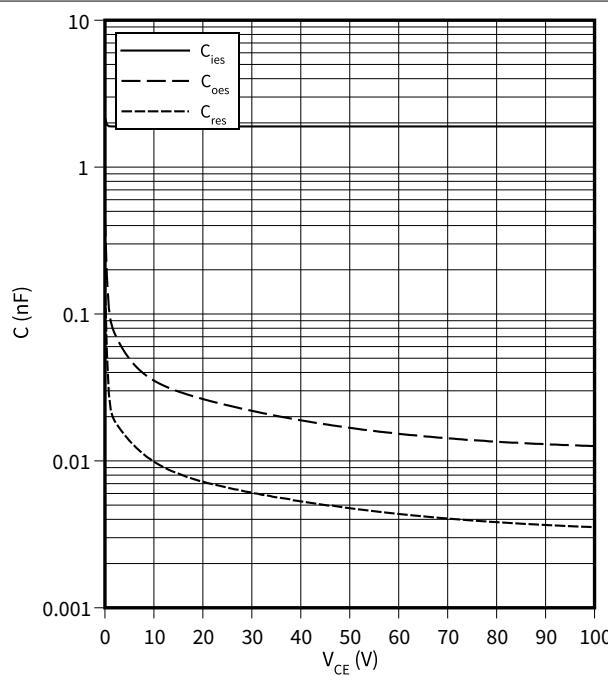
$$R_{Goff} = 8.2 \Omega, V_{GE} = \pm 15 V, T_{vj} = 175^\circ C$$



capacity characteristic (typical), IGBT, Inverter

$$C = f(V_{CE})$$

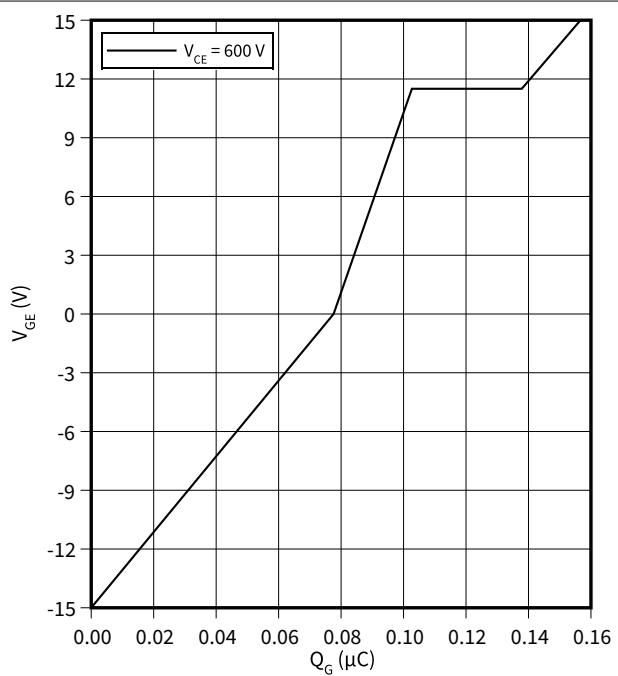
$$T_{vj} = 25^\circ C, V_{GE} = 0 V, f = 100 \text{ kHz}$$



gate charge characteristic (typical), IGBT, Inverter

$$V_{GE} = f(Q_G)$$

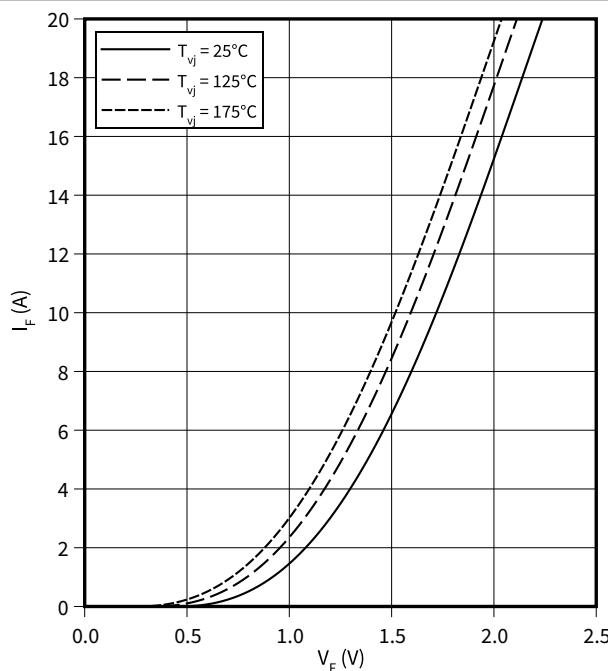
$$I_C = 10 A, T_{vj} = 25^\circ C$$



8 Characteristics diagrams

forward characteristic (typical), Diode, Inverter

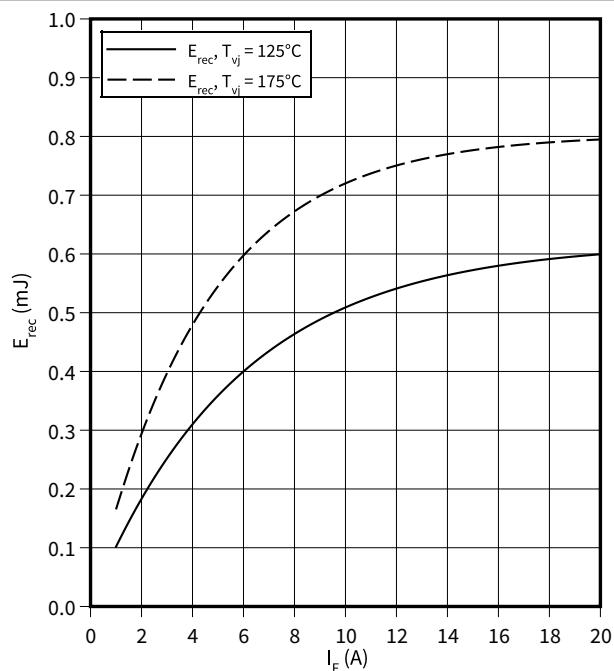
$$I_F = f(V_F)$$



switching losses (typical), Diode, Inverter

$$E_{rec} = f(I_F)$$

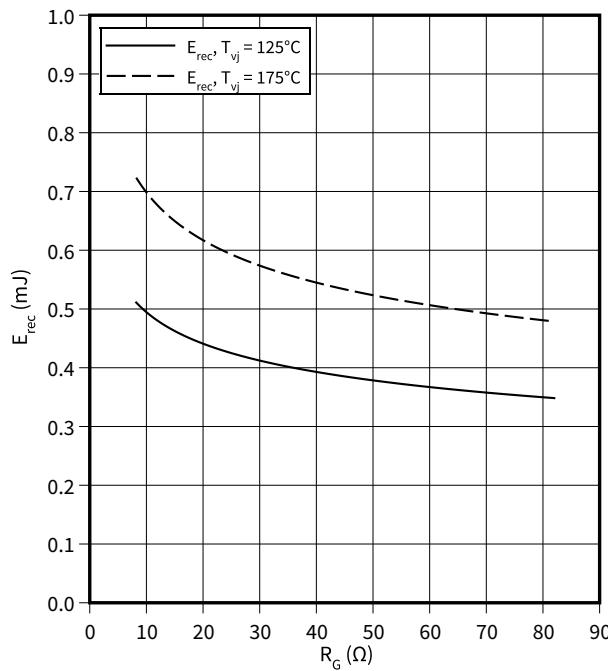
V_{CE} = 600 V, R_{Gon} = 8.2 Ω



switching losses (typical), Diode, Inverter

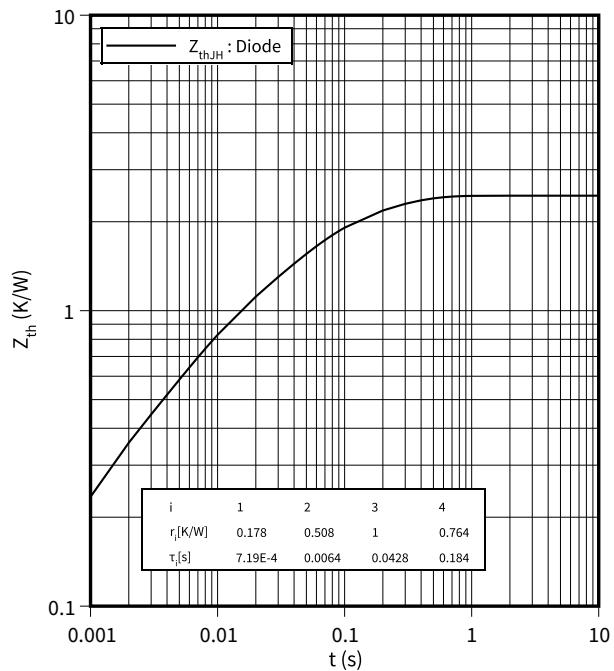
$$E_{rec} = f(R_G)$$

V_{CE} = 600 V, I_F = 10 A



transient thermal impedance , Diode, Inverter

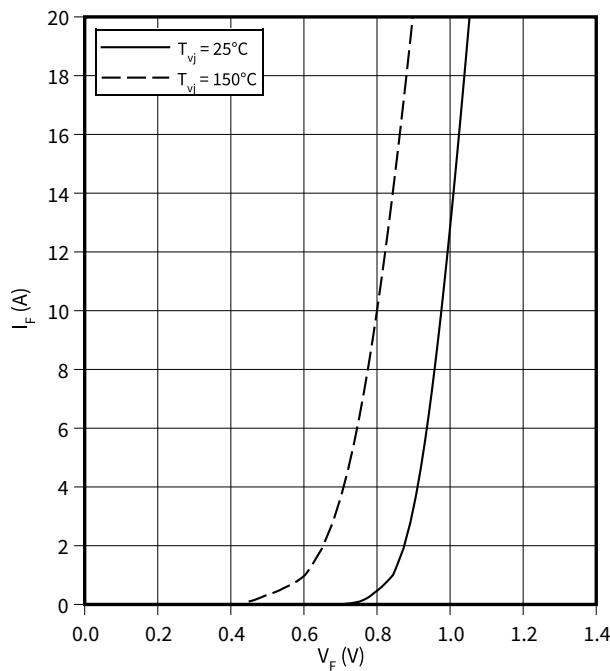
$$Z_{th} = f(t)$$



8 Characteristics diagrams

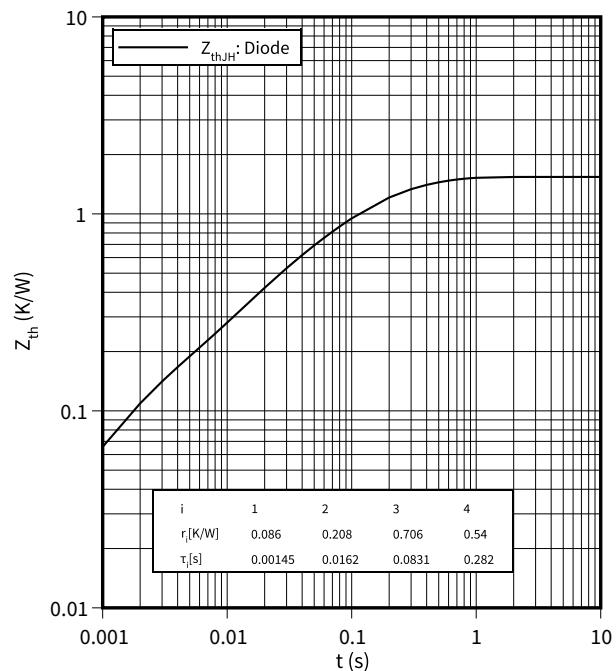
forward characteristic (typical), Diode, Rectifier

$$I_F = f(V_F)$$



transient thermal impedance , Diode, Rectifier

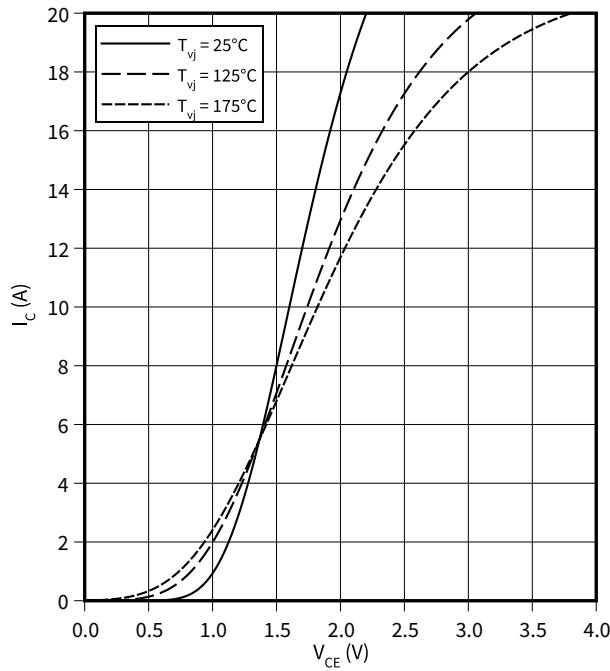
$$Z_{th} = f(t)$$



output characteristic (typical), IGBT, Brake-Chopper

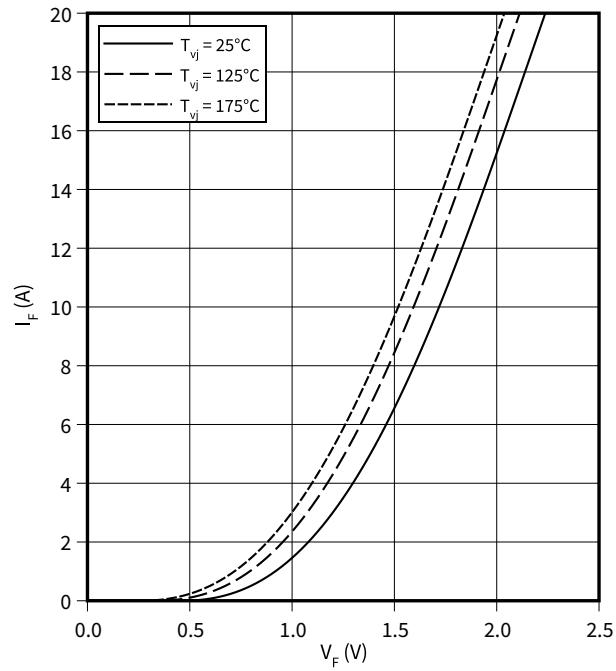
$$I_C = f(V_{CE})$$

V_{GE} = 15 V



forward characteristic (typical), Diode, Brake-Chopper

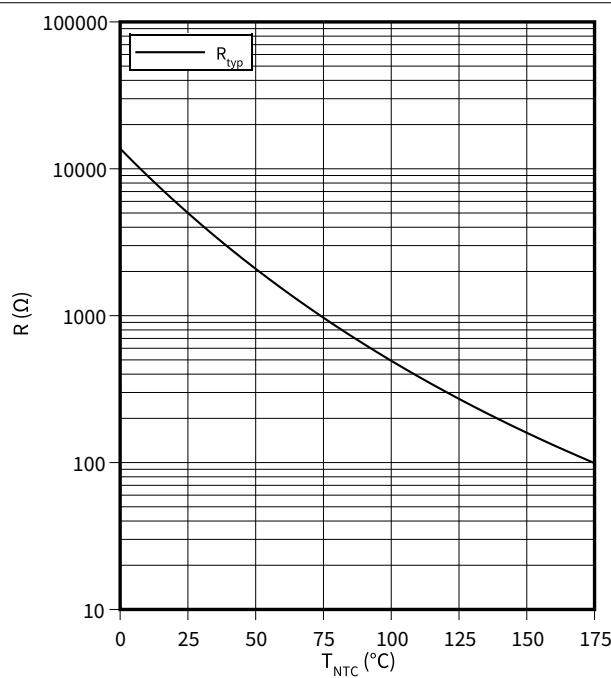
$$I_F = f(V_F)$$



8 Characteristics diagrams

temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



9 Circuit diagram

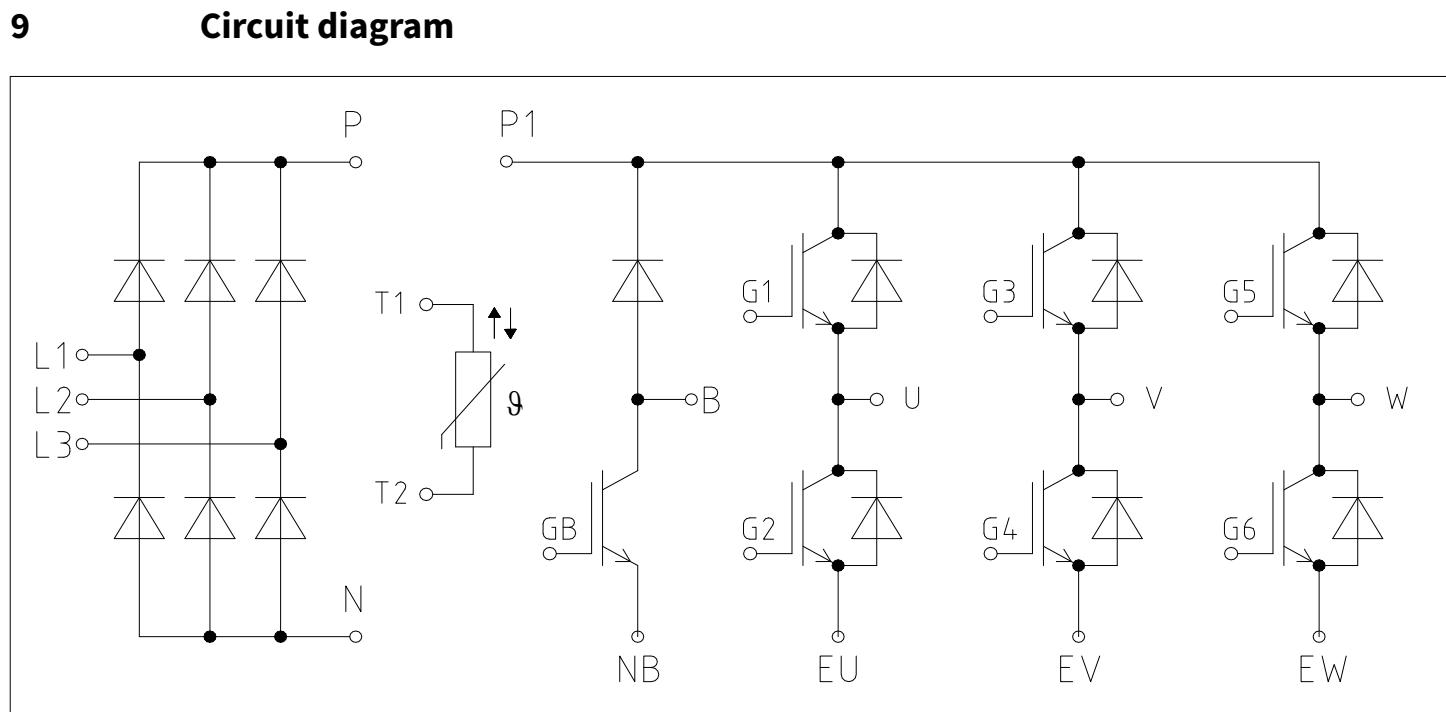


Figure 2

10 Package outlines

10 Package outlines

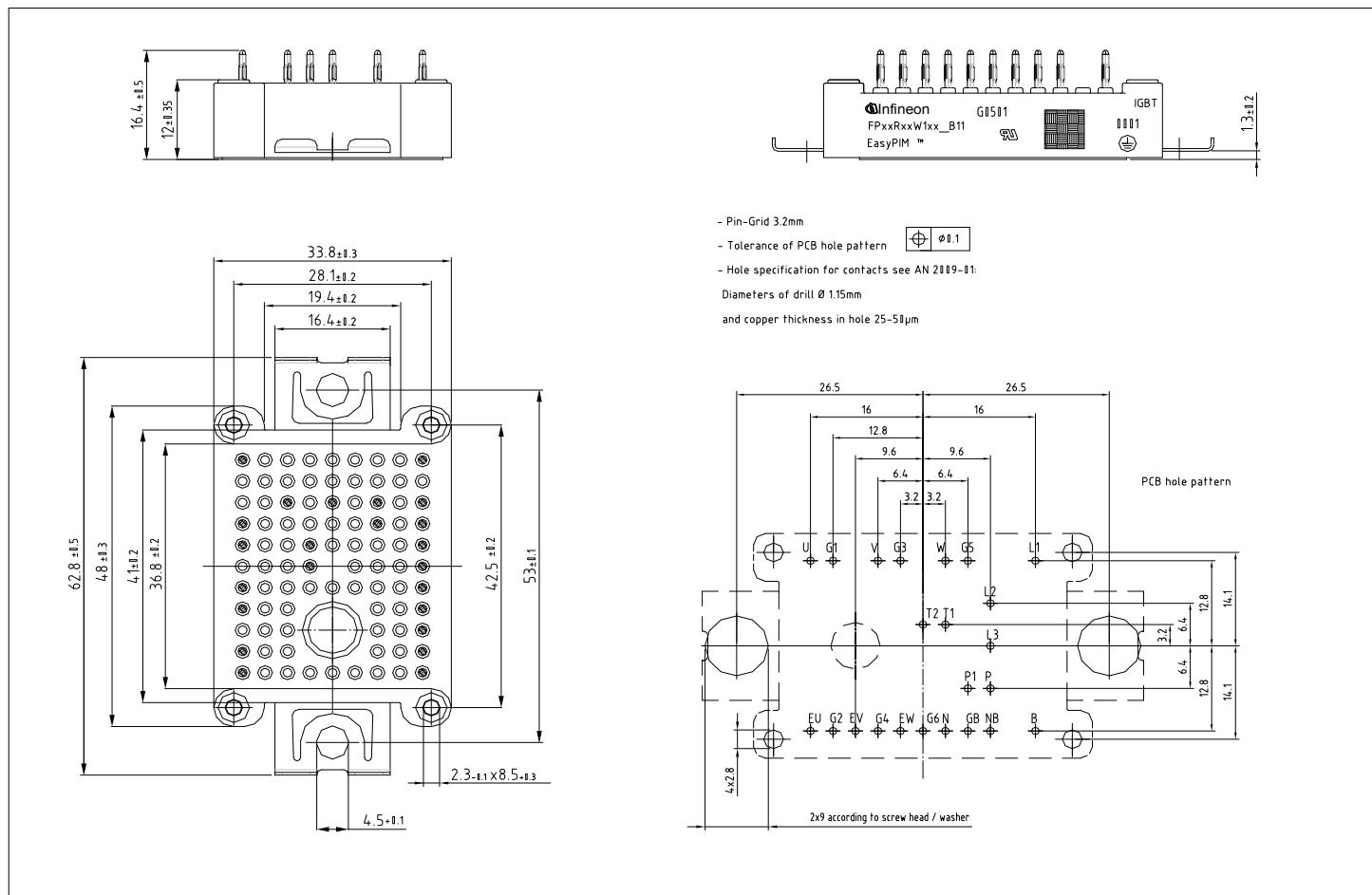


Figure 3

11 Module label code

11 Module label code

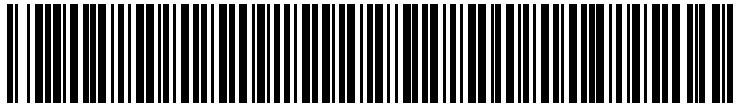
Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week)	<i>Digit</i> 1 – 5 6 - 11 12 - 19 20 – 21 22 – 23	<i>Example</i> 71549 142846 55054991 15 30
Example	 71549142846550549911530	 71549142846550549911530	

Figure 4

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